



US00D960121S

(12) **United States Design Patent** (10) **Patent No.:** **US D960,121 S**
Liu et al. (45) **Date of Patent:** **** Aug. 9, 2022**

(54) **MOBILE PHONE**

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(71) Applicant: **Beijing Xiaomi Mobile Software Co., Ltd.**, Beijing (CN)

(57) **CLAIM**

(72) Inventors: **Zhenhua Liu**, Beijing (CN); **Yangyang Cai**, Beijing (CN); **Yue Qin**, Beijing (CN)

The ornamental design for a mobile phone, as shown and described.

(73) Assignee: **Beijing Xiaomi Mobile Software Co., Ltd.**, Beijing (CN)

DESCRIPTION

(**) Term: **15 Years**

FIG. 1 is a front view of a first embodiment of a mobile phone showing our new design in an off state; FIG. 2 is a back view of the mobile phone of FIG. 1; FIG. 3 is a left view of the mobile phone of FIG. 1; FIG. 4 is a right view of the mobile phone of FIG. 1; FIG. 5 is a top view of the mobile phone of FIG. 1; FIG. 6 is a bottom view of the mobile phone of FIG. 1; FIG. 7 is a bottom, front, right perspective view of the mobile phone of FIG. 1; FIG. 8 is a bottom, back, left perspective view of the mobile phone of FIG. 1; FIG. 9 is a front view of the mobile phone of FIG. 1, shown in a state of use; FIG. 10 is a bottom, front, right perspective view of the mobile phone of FIG. 1, shown in the state of use; FIG. 11 is a front view of a second embodiment of a mobile phone showing our new design, in an off state; FIG. 12 is a back view of the mobile phone of FIG. 11; FIG. 13 is a left view of the mobile phone of FIG. 11; FIG. 14 is a right view of the mobile phone of FIG. 11; FIG. 15 is a top view of the mobile phone of FIG. 11; FIG. 16 is a bottom view of the mobile phone of FIG. 11; FIG. 17 is a bottom, front, right perspective view of the mobile phone of FIG. 11; FIG. 18 is a bottom, back, left perspective view of the mobile phone of FIG. 11; FIG. 19 is a front view of the mobile phone of FIG. 11, shown in a state of use; and, FIG. 20 is a bottom, front, right perspective view of the mobile phone of FIG. 11, shown in the state of use.

(21) Appl. No.: **29/753,810**

(22) Filed: **Oct. 2, 2020**

Related U.S. Application Data

(62) Division of application No. 29/690,092, filed on May 6, 2019, now Pat. No. Des. 908,654.

(30) **Foreign Application Priority Data**

Nov. 7, 2018 (CN) 201830628810.0

(51) **LOC (13) Cl.** **14-03**

(52) **U.S. Cl.**
USPC **D14/138 G**

(58) **Field of Classification Search**
USPC D14/138 G, 138 AD, 138 AB, 248, 341, D14/345, 432, 439, 371, 374, 138 R, D14/138 AA, 138 AC, 138 C
(Continued)

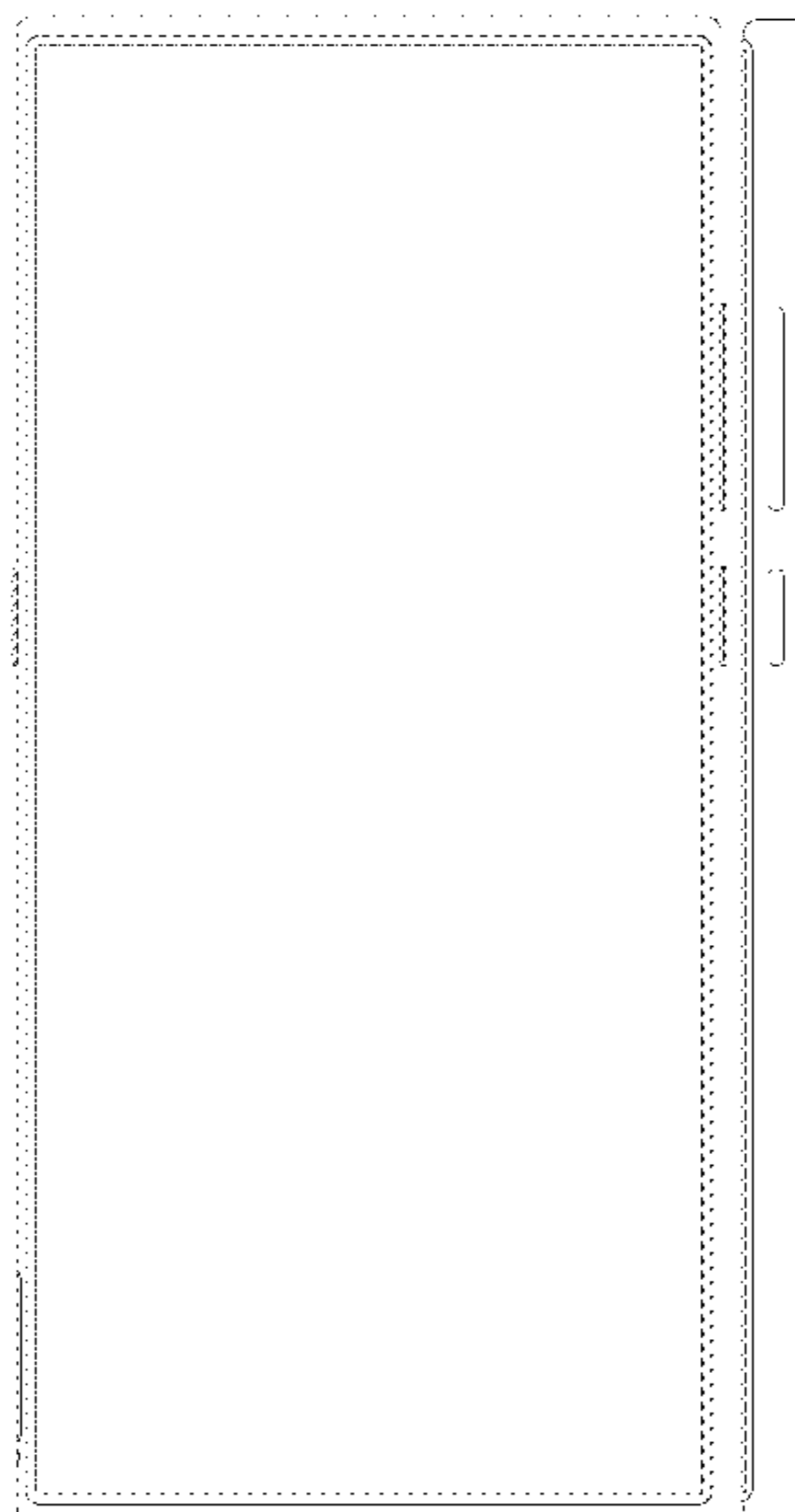
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Primary Examiner — Bridget L Eland

1 Claim, 14 Drawing Sheets



(58) **Field of Classification Search**

CPC H04M 1/0202; H04M 1/0235; H04M
1/0237; H04M 1/0239; H04M 1/0266;
H04M 1/0268; H04M 1/027; H04M
1/0295; H04M 1/02; H04M 1/0279;
H04M 1/0283

See application file for complete search history.

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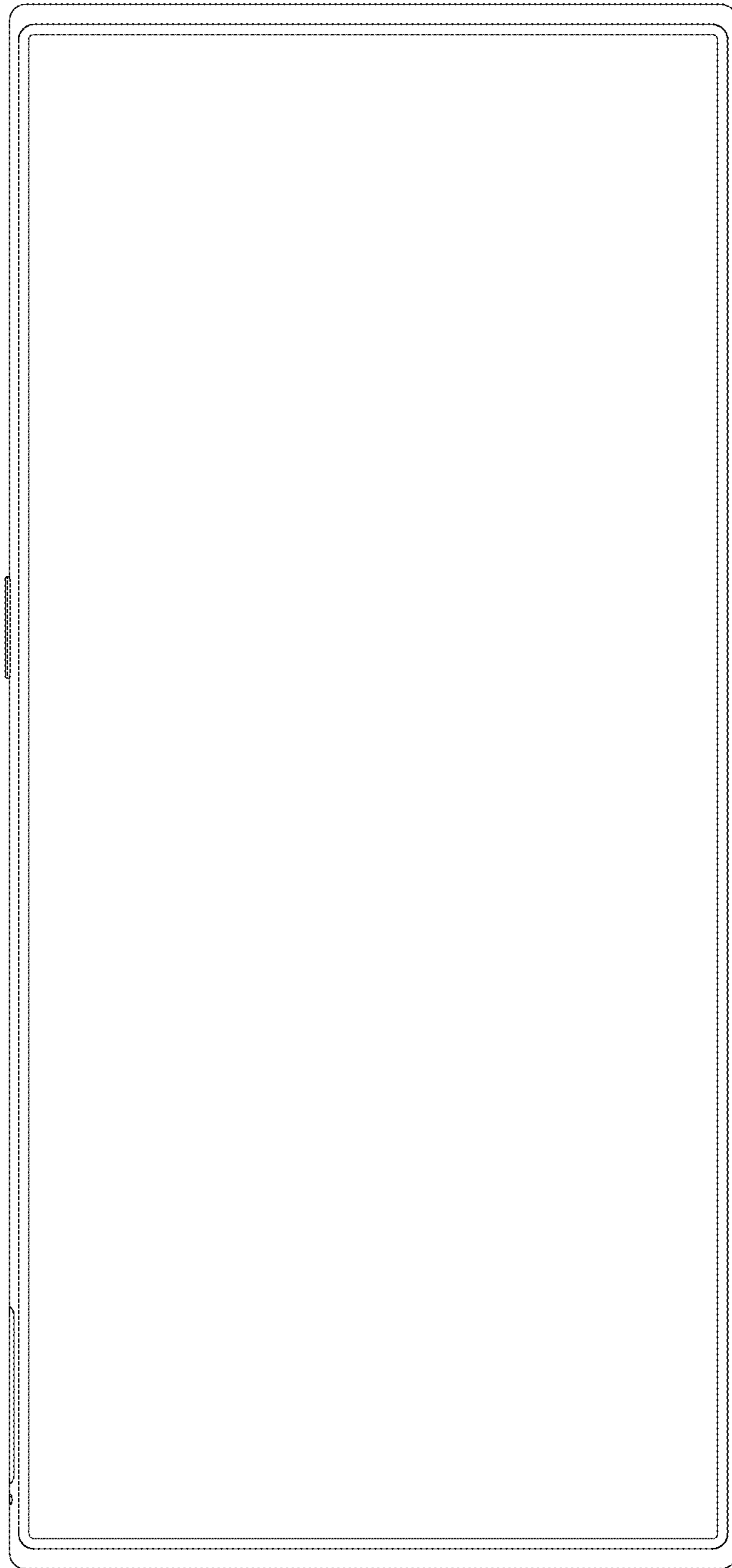


Fig. 1

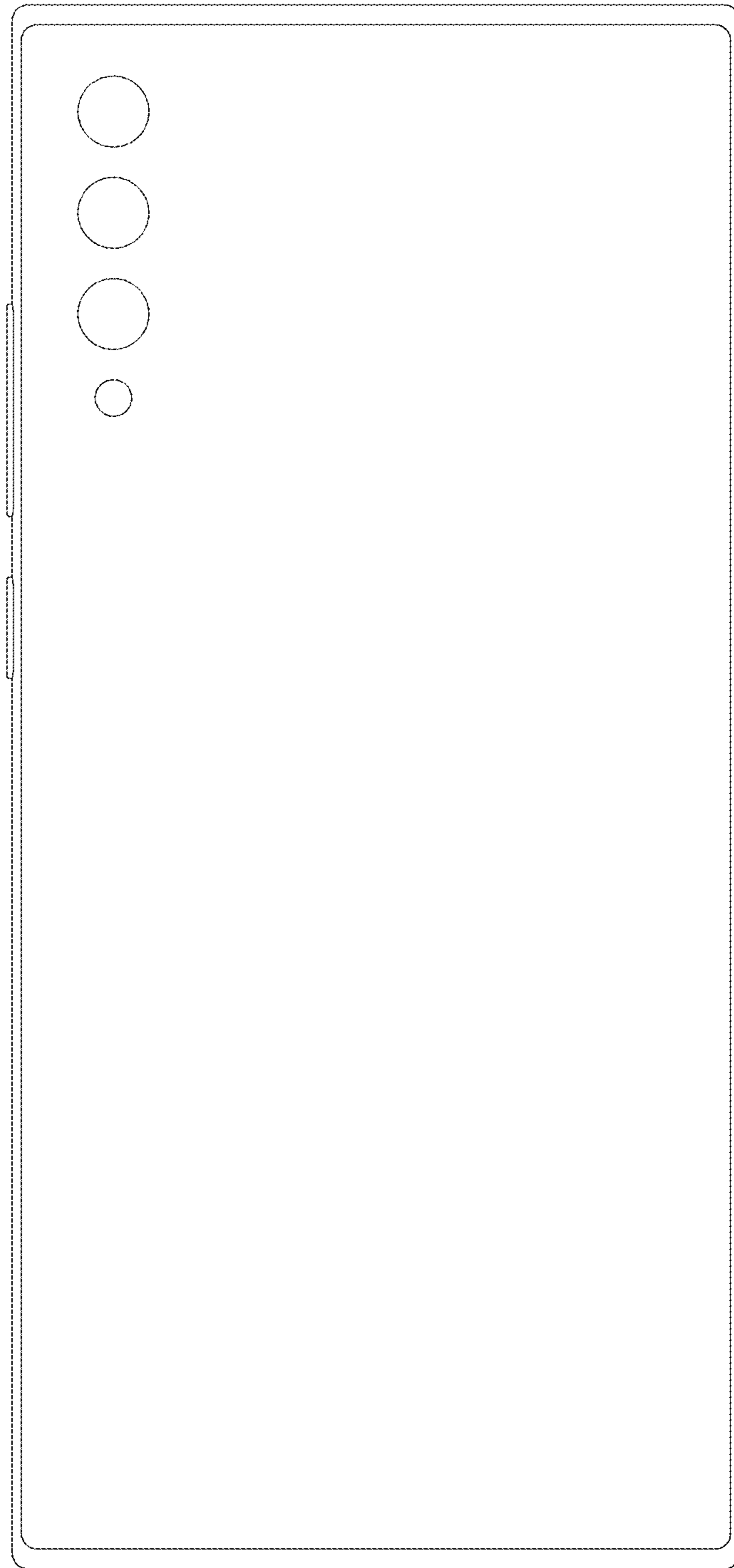


Fig. 2

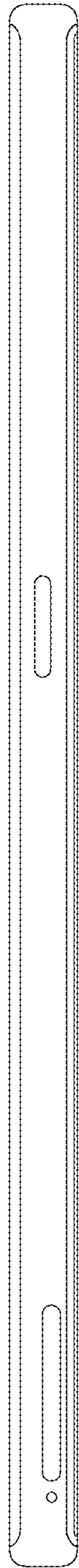


Fig. 3

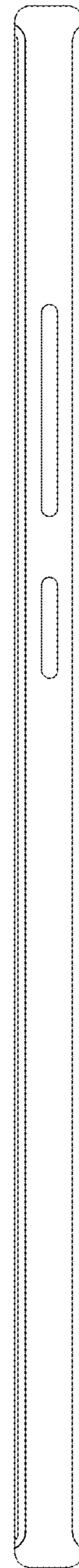


Fig. 4

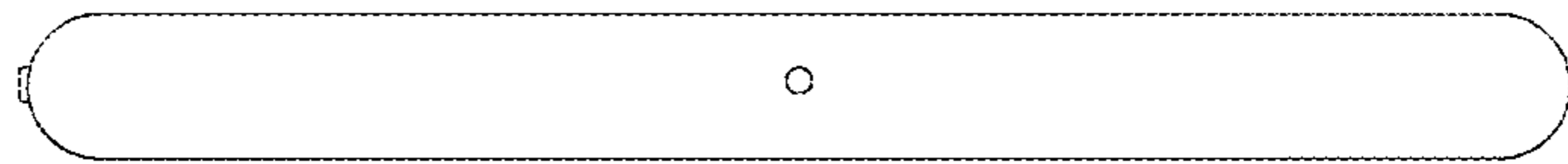


Fig. 5

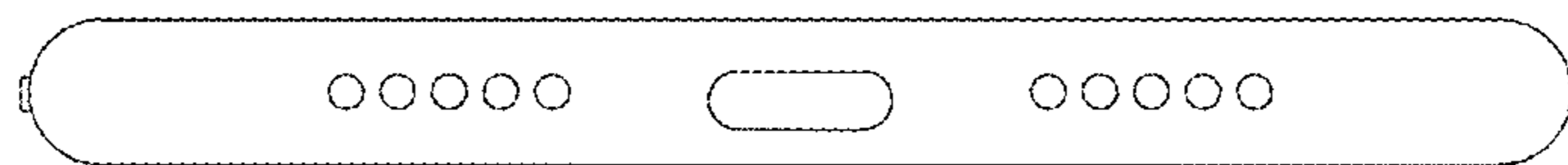


Fig. 6

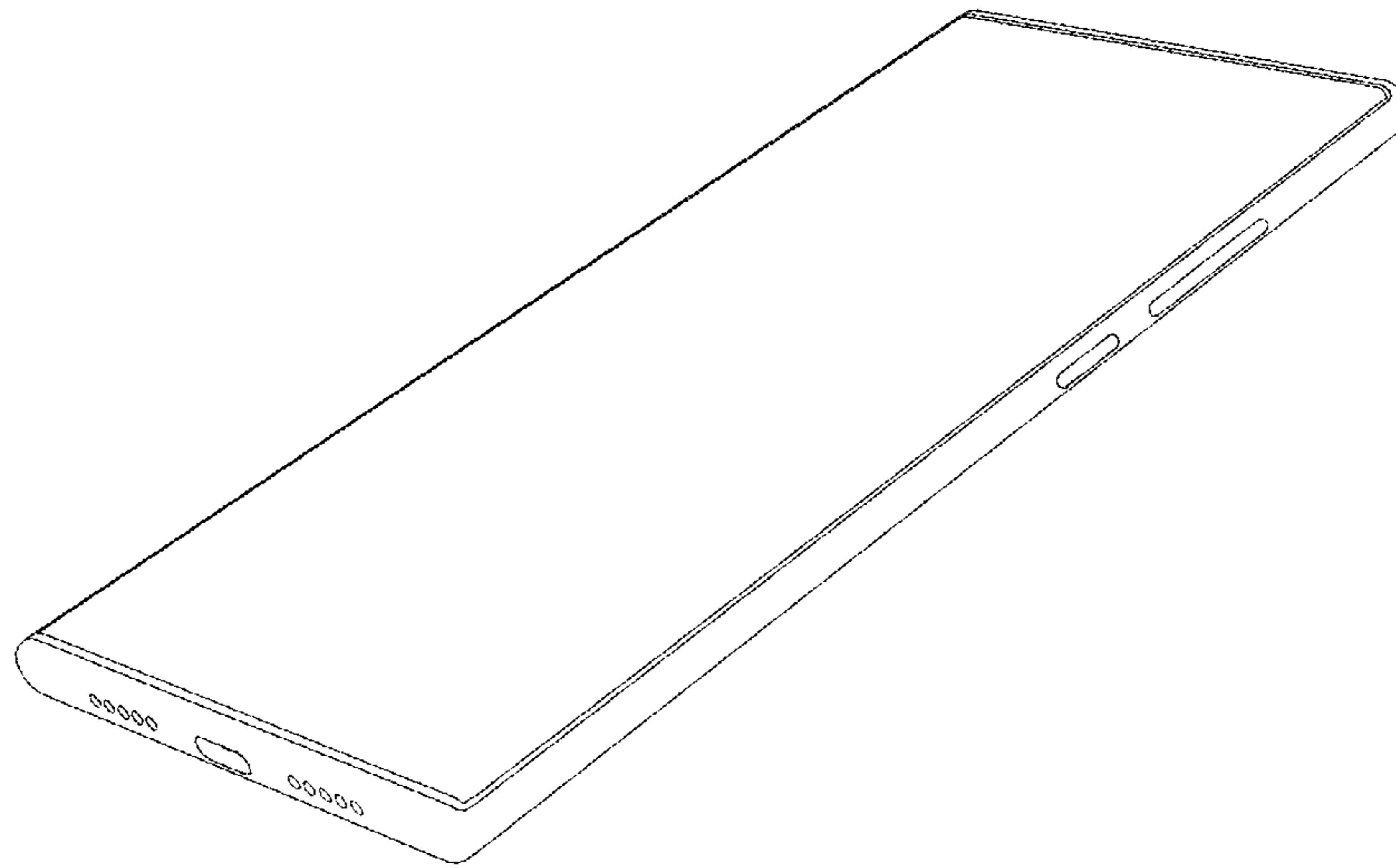


Fig. 7

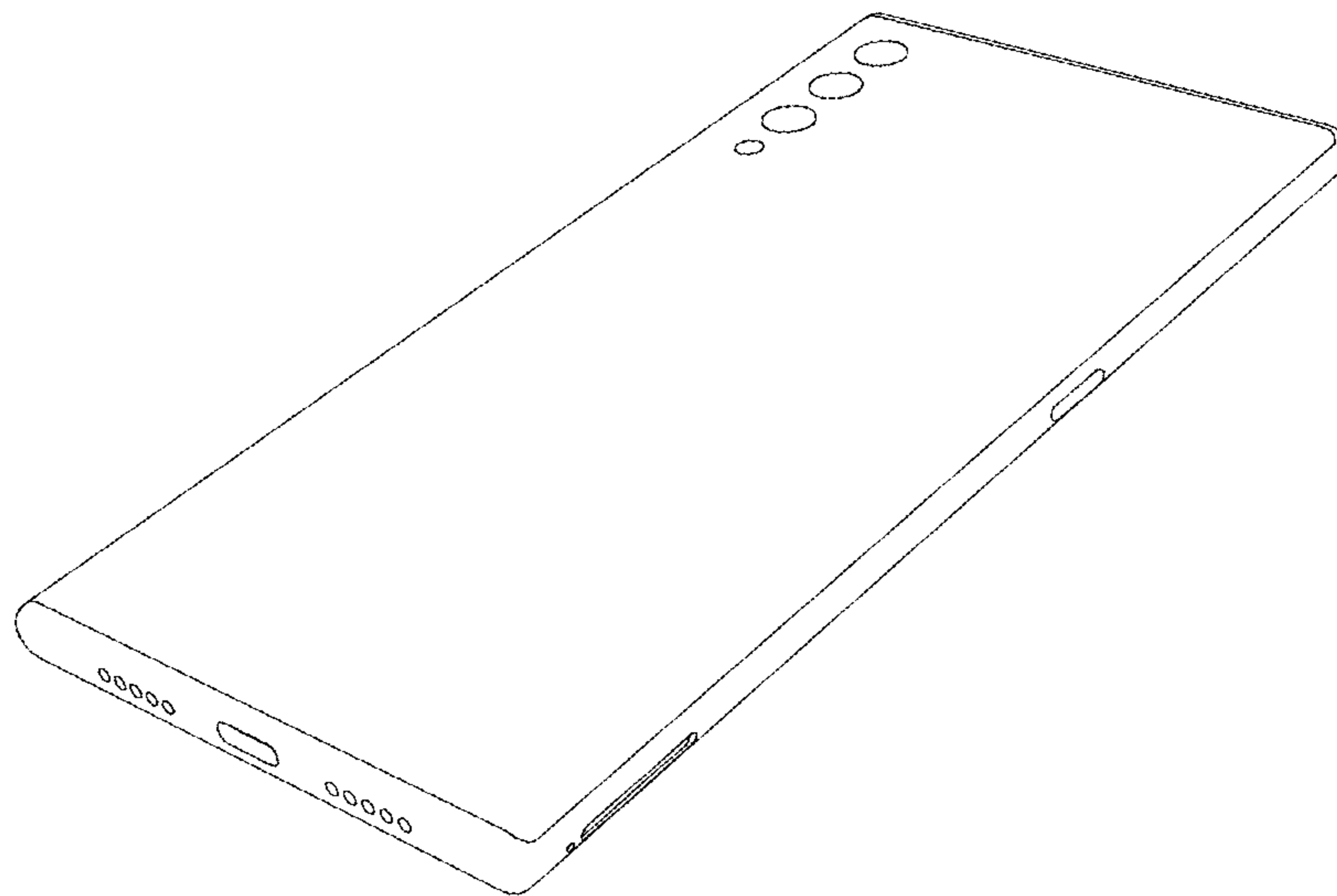


Fig. 8

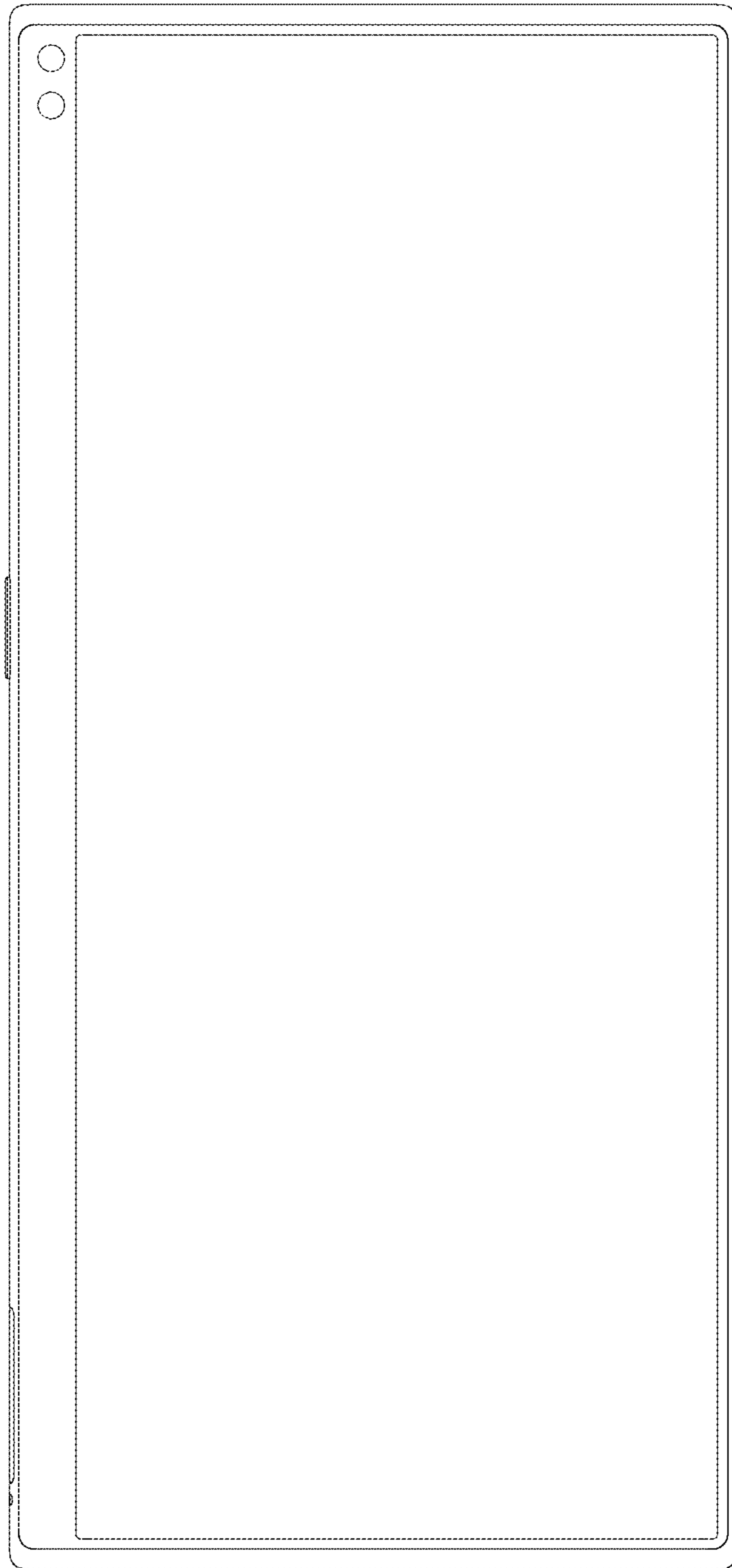


Fig. 9

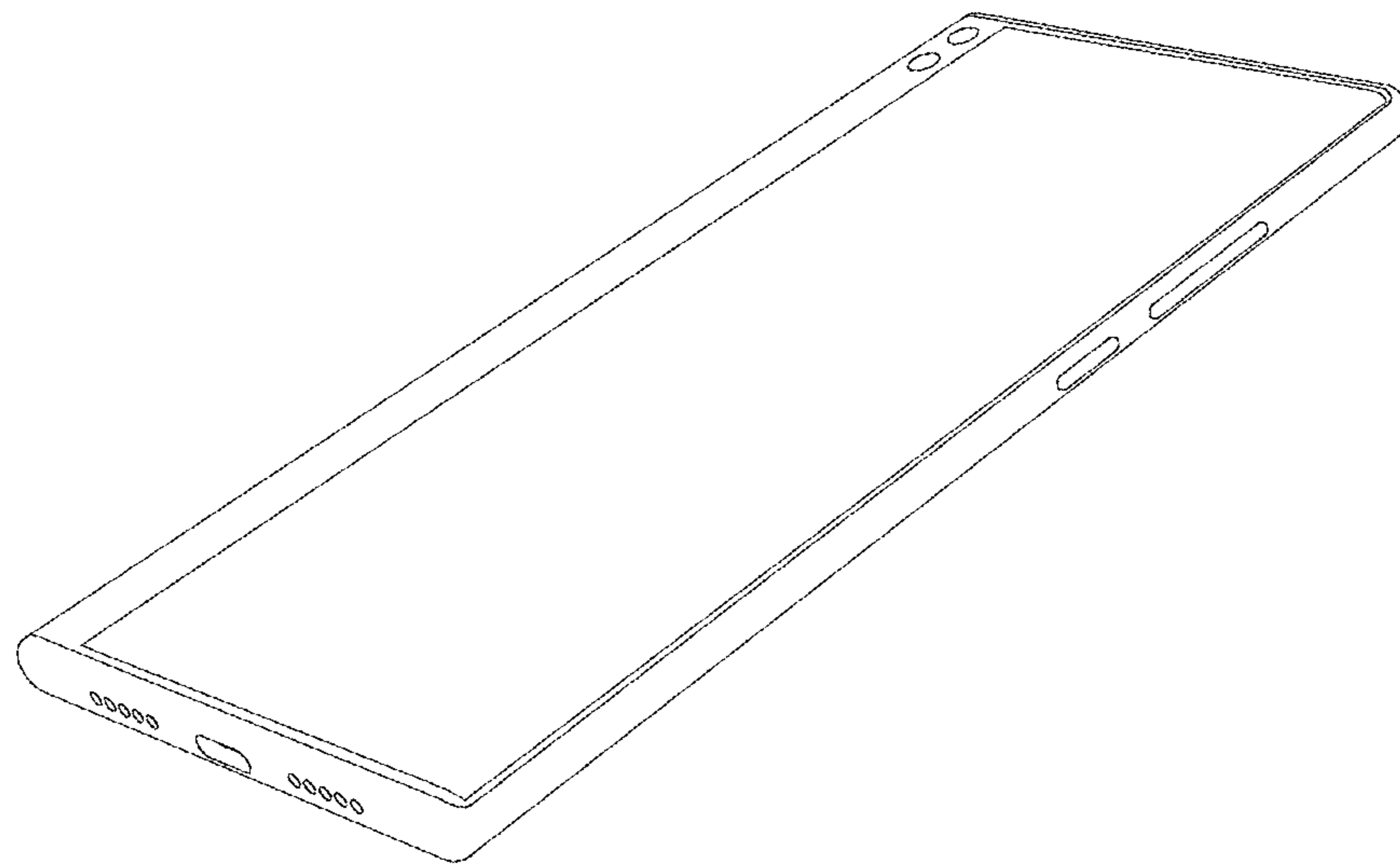


Fig. 10

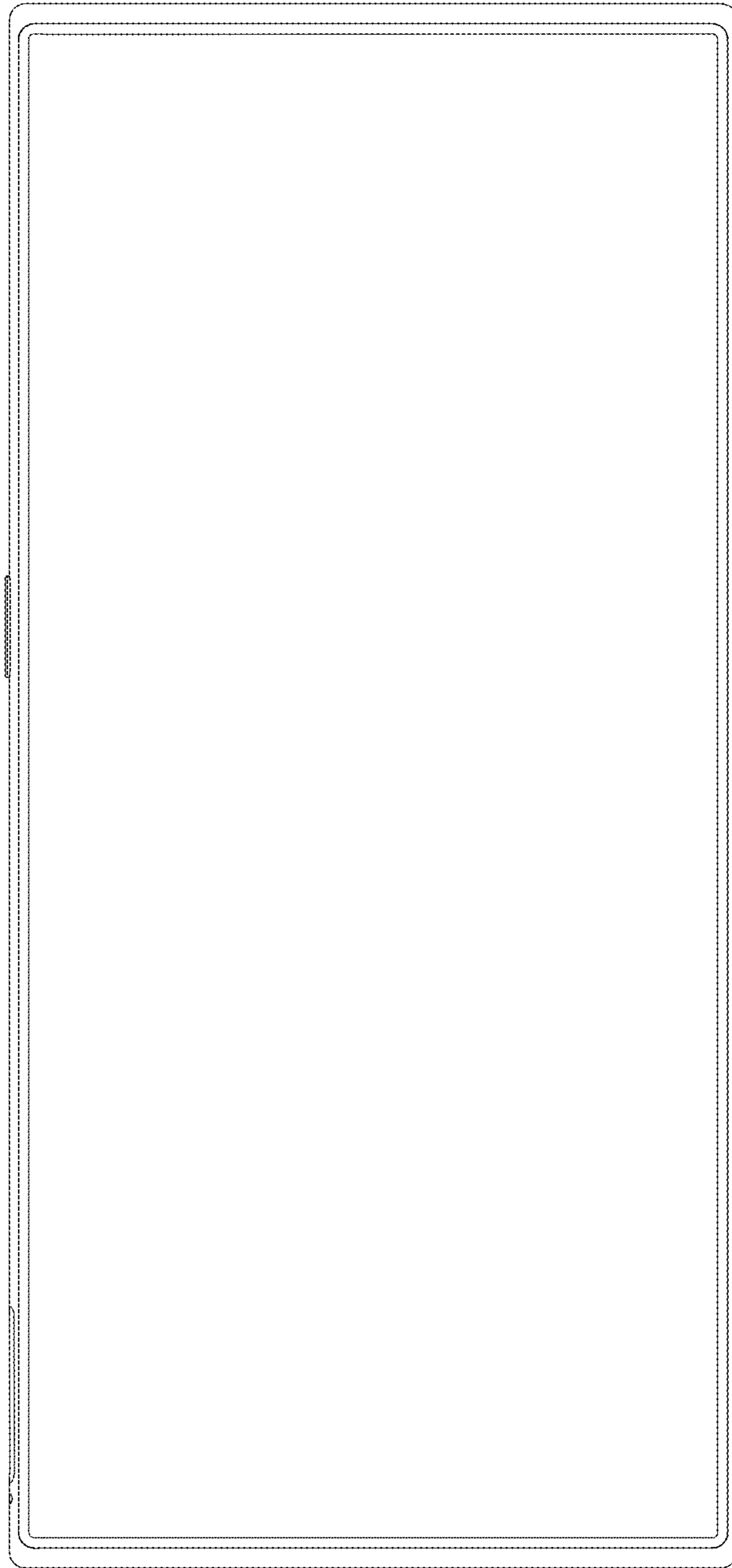


Fig. 11

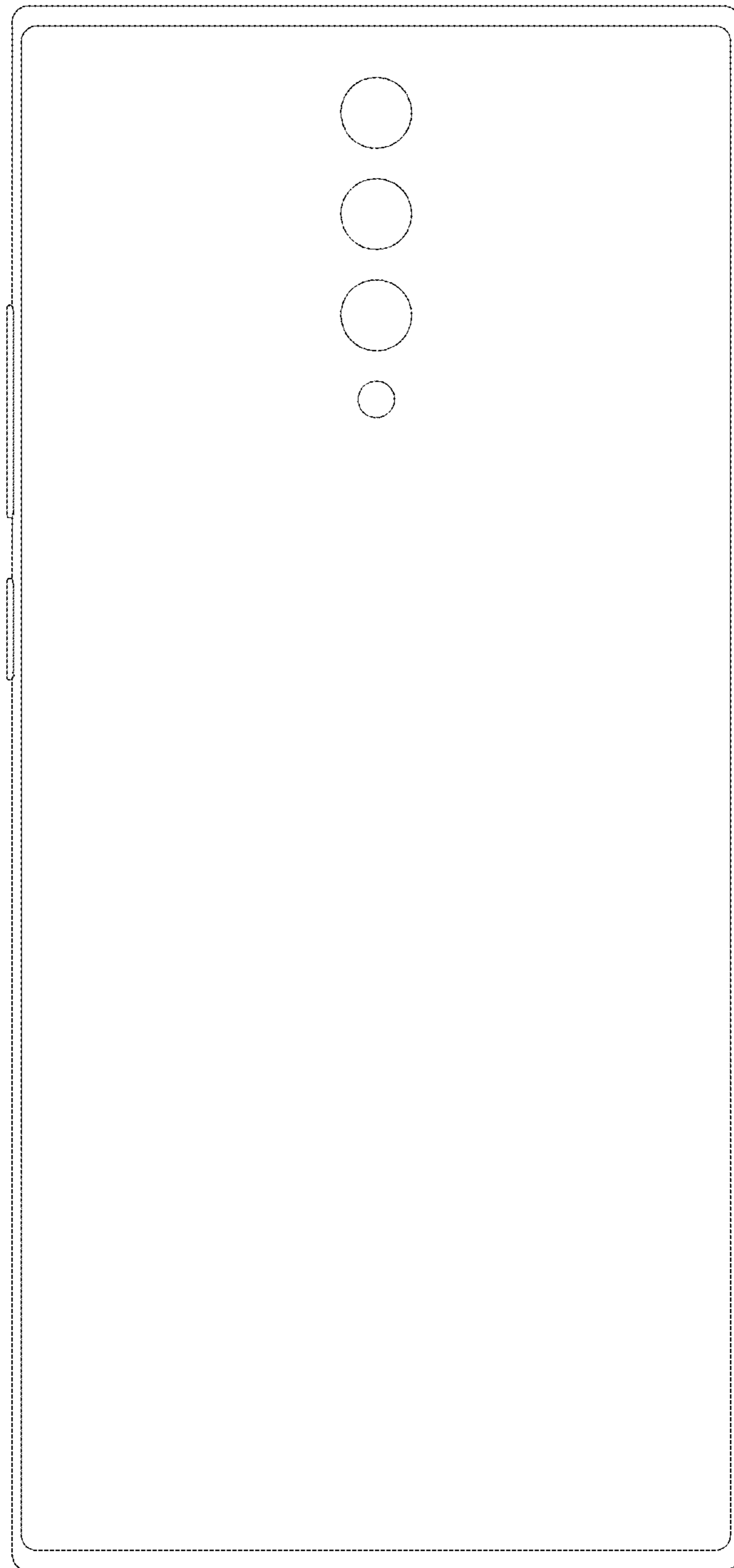


Fig. 12

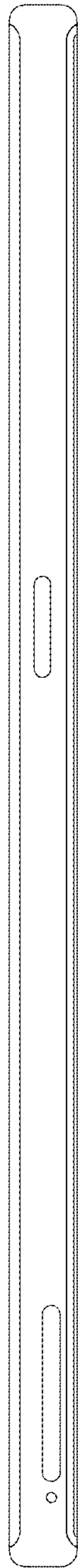


Fig. 13

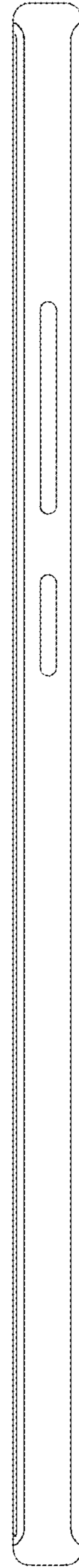


Fig. 14

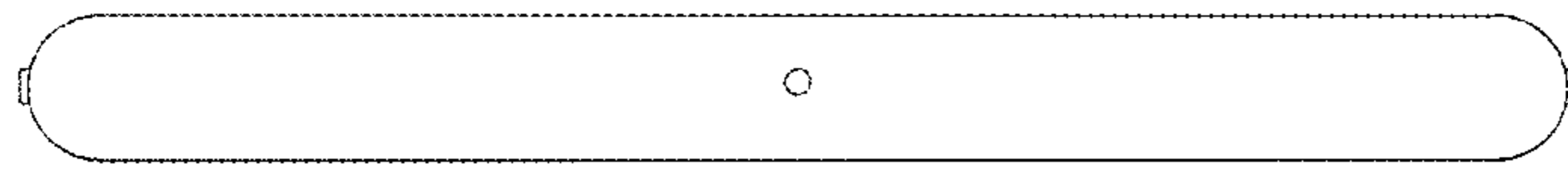


Fig. 15

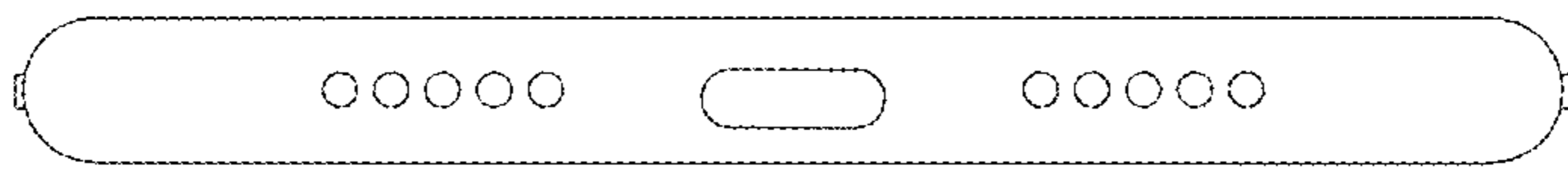


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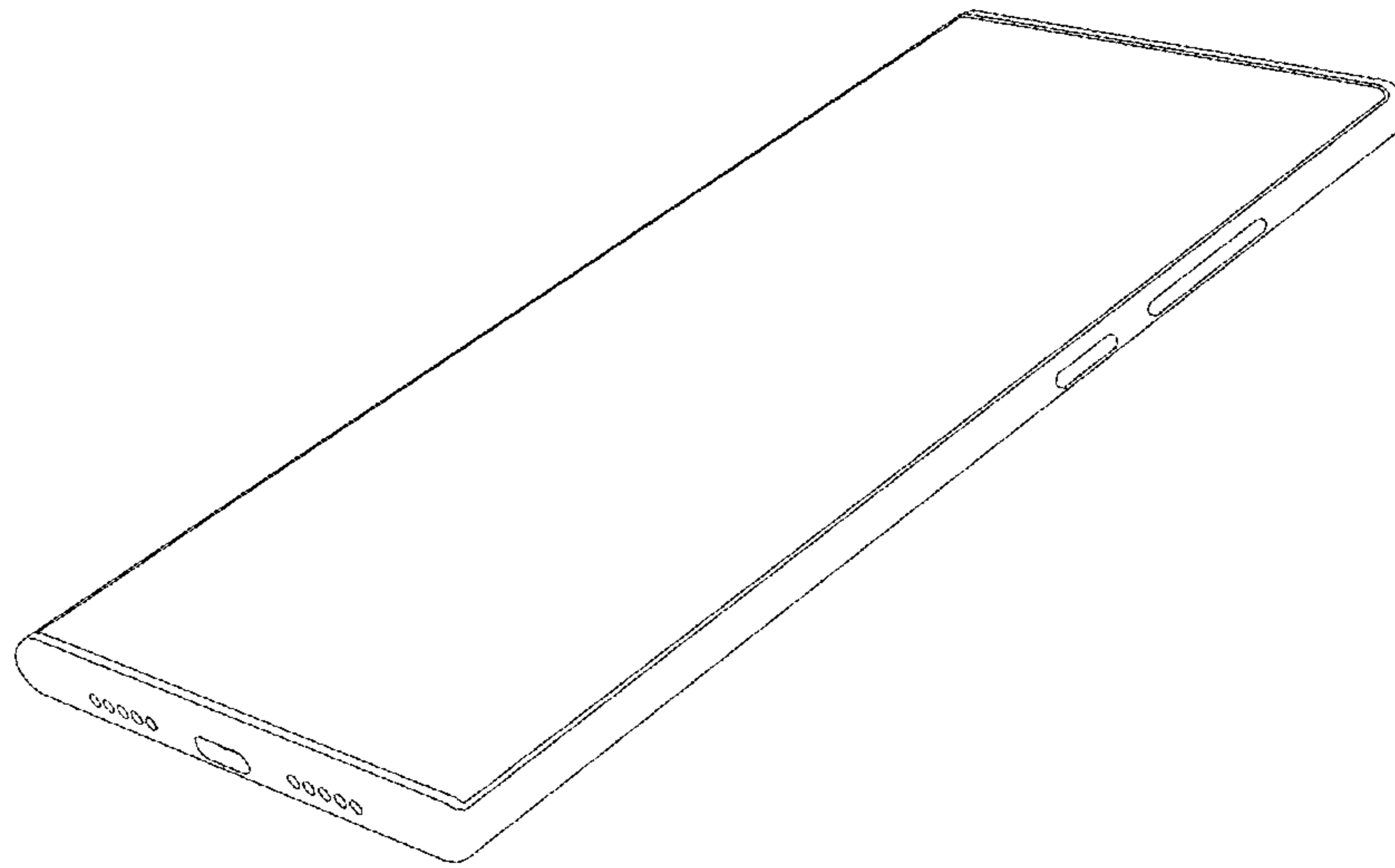


Fig. 17

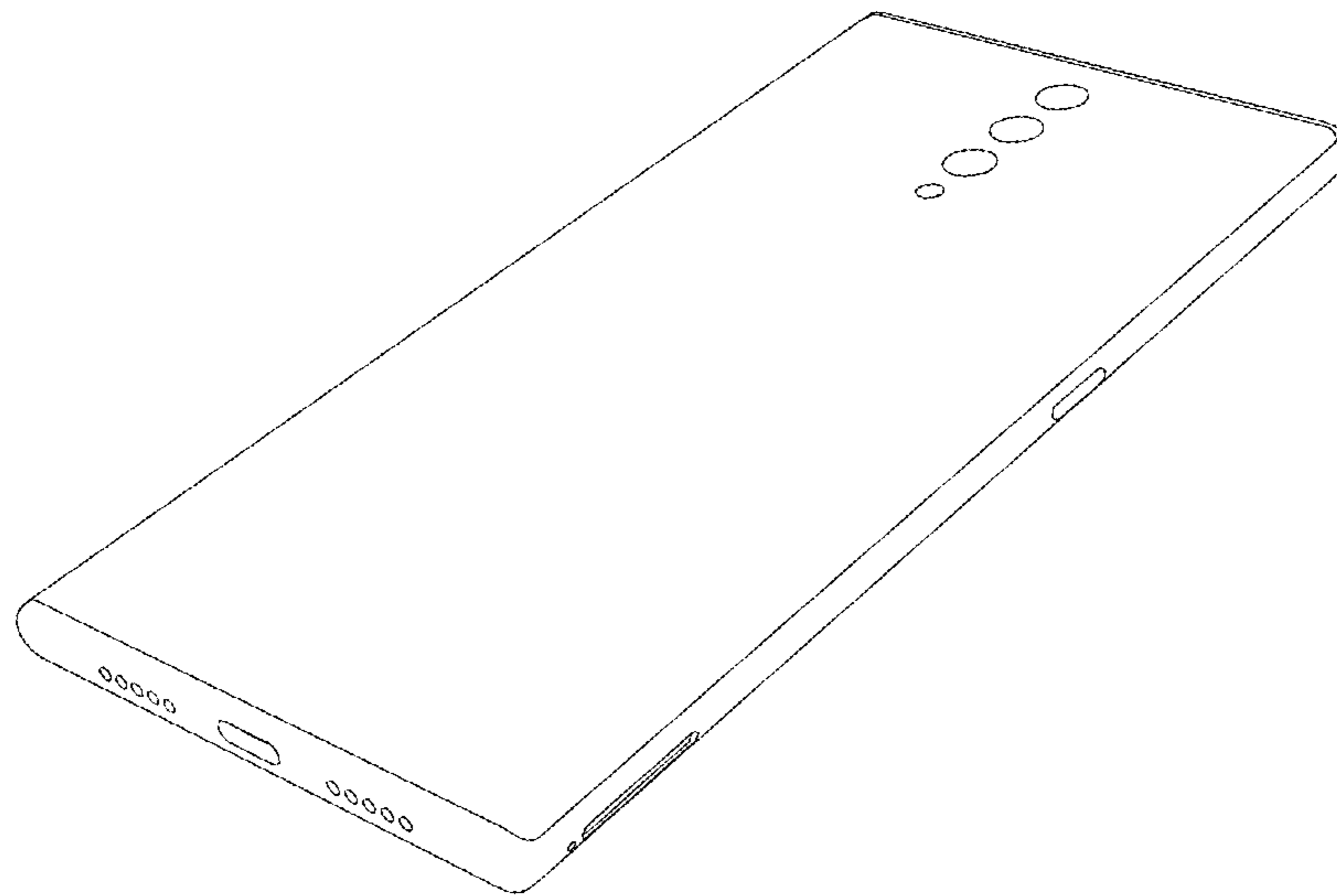


Fig. 18

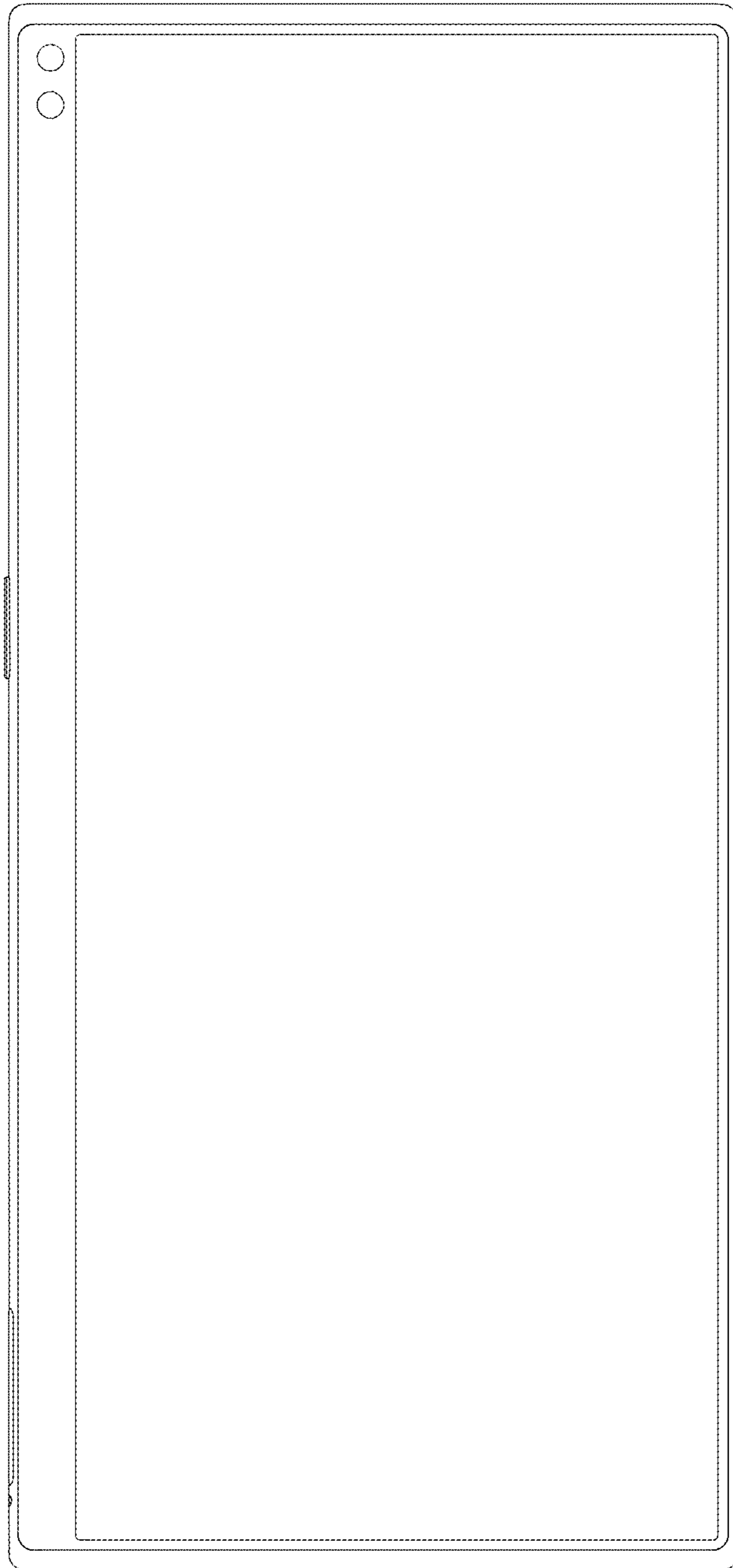


Fig. 19

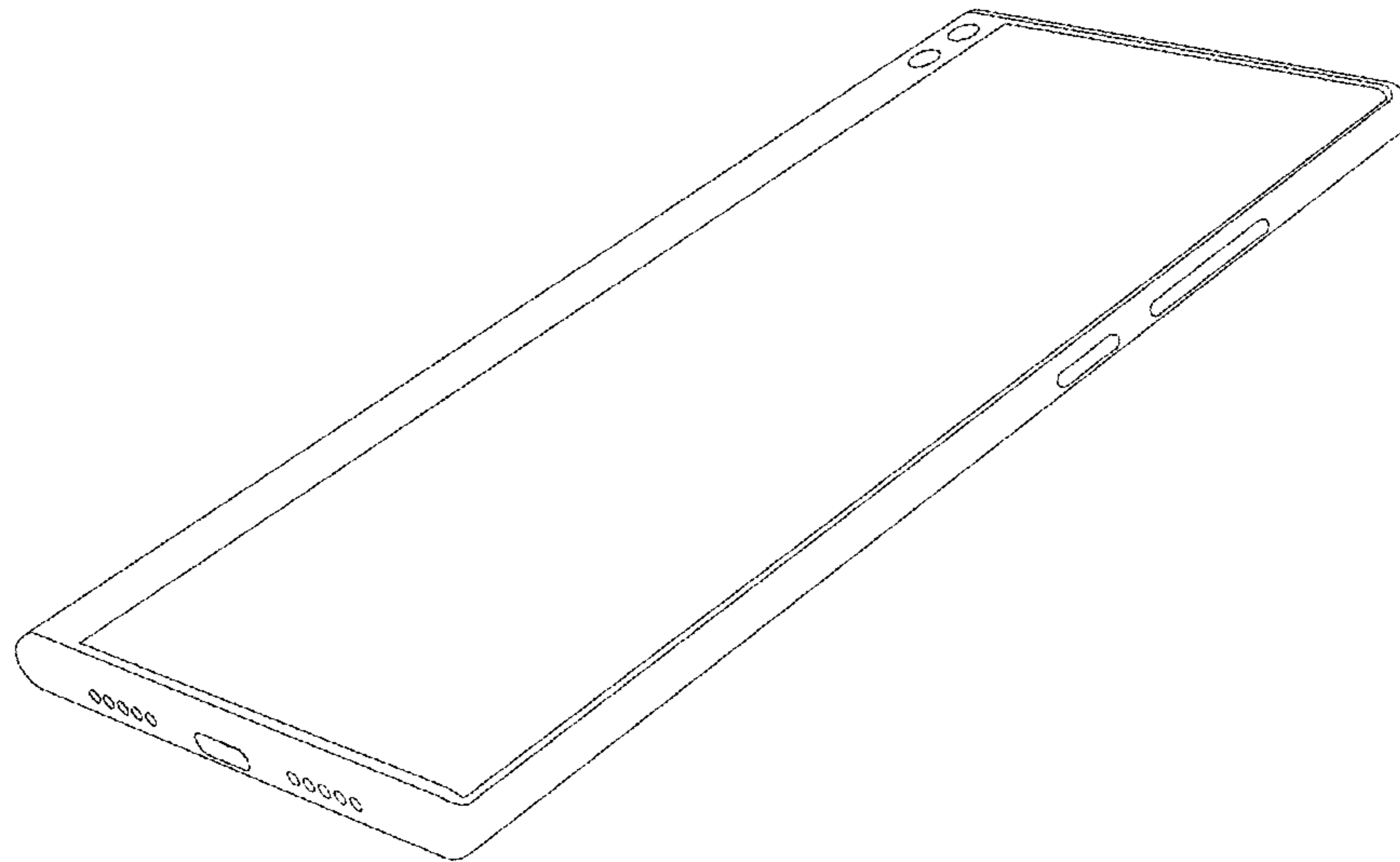


Fig. 20